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ABSTRACT

A photosensitive composition for forming a dielectric of the present invention comprising inorganic particles, an alkali developable resin and additives, wherein the

5 additives comprise a compound having a quinonediazido group (C1), a compound containing at least two alkyletherified amino groups in the molecule (C2) and a thermal acid generator (C3), or wherein the inorganic particles comprise inorganic superfine particles (A-I) having a mean particle

10 diameter of less than $0.05\mu\text{m}$ and inorganic fine particles (A-II) having a mean particle diameter of not less than $0.05\mu\text{m}$.

The composition can be calcined at low temperatures to form a dielectric layer with high dimensional precision,

15 said layer having a high dielectric constant and a low dielectric loss. Also provided are a dielectric and an electronic part prepared from the composition.